

# 54ABT240

*54ABT240 Octal Buffer/Line Driver with TRI-STATE Outputs*



Literature Number: SNOS040

## 54ABT240

### Octal Buffer/Line Driver with TRI-STATE® Outputs

#### General Description

The 'ABT240 is an inverting octal buffer and line driver designed to be employed as a memory address driver, clock driver and bus oriented transmitter or receiver which provides improved PC board density.

- Guaranteed latching protection
- High impedance glitch free bus loading during entire power up and power down cycle
- Nondestructive hot insertion capability
- Standard Microcircuit Drawing (SMD)—5962-9318801

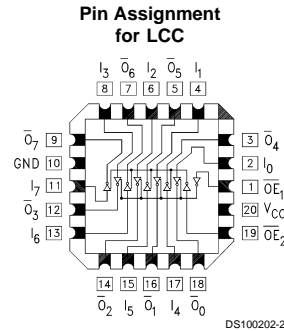
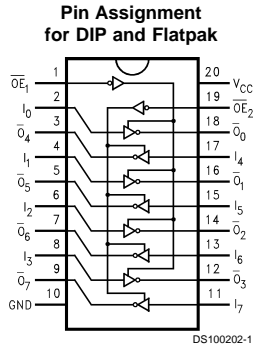
#### Features

- Output sink capability of 48 mA, source capability of 24 mA

#### Ordering Code

| Military      | Package Number | Package Description                           |
|---------------|----------------|---|
| 54ABT240J-QML | J20A           | 20-Lead Ceramic Dual-In-Line                  |
| 54ABT240W-QML | W20A           | 20-Lead Cerpack                               |
| 54ABT240E-QML | E20A           | 20-Lead Ceramic Leadless Chip Carrier, Type C |

#### Connection Diagrams



| Pin Names                          | Description                    |
|------------------------------------|--------------------------------|
| $\overline{OE}_1, \overline{OE}_2$ | TRI-STATE Output Enable Inputs |
| $I_0-I_7$                          | Inputs                         |
| $\overline{O}_0-\overline{O}_7$    | Outputs                        |

TRI-STATE® is a registered trademark of National Semiconductor Corporation.

## Truth Tables

| Inputs            |       | Outputs<br>(Pins 12, 14, 16, 18) |
|-------------------|-------|----------------------------------|
| $\overline{OE}_1$ | $I_n$ |                                  |
| L                 | L     | H                                |
| L                 | H     | L                                |
| H                 | X     | Z                                |

| Inputs            |       | Outputs<br>(Pins 3, 5, 7, 9) |
|-------------------|-------|------------------------------|
| $\overline{OE}_2$ | $I_n$ |                              |
| L                 | L     | H                            |
| L                 | H     | L                            |
| H                 | X     | Z                            |

H = HIGH Voltage Level  
L = LOW Voltage Level  
X = Immaterial  
Z = High Impedance

## Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

|  |                          |
|--|--------------------------|
| Storage Temperature  | -65°C to +150°C          |
| Ambient Temperature under Bias                                   | -55°C to +125°C          |
| Junction Temperature under Bias                                  |                          |
| Ceramic  | -55°C to +175°C          |
| V <sub>CC</sub> Pin Potential to Ground Pin                      | -0.5V to +7.0V           |
| Input Voltage (Note 2)   | -0.5V to +7.0V           |
| Input Current (Note 2)   | -30 mA to +5.0 mA        |
| Voltage Applied to Any Output in the Disabled or Power-Off State | -0.5V to 5.5V            |
| in the HIGH State  | -0.5V to V <sub>CC</sub> |

|   |                                      |
|---|--------------------------------------|
| Current Applied to Output in LOW State (Max)            | twice the rated I <sub>OL</sub> (mA) |
| DC Latchup Source Current (Across Comm Operating Range) | -150 mA                              |
| Over Voltage Latchup (I/O)                              | 10V                                  |

## Recommended Operating Conditions

|                                 |                 |
|---------------------------------|-----------------|
| Free Air Ambient Temperature    |                 |
| Military                        | -55°C to +125°C |
| Supply Voltage                  |                 |
| Military                        | +4.5V to +5.5V  |
| Minimum Input Edge Rate (ΔV/Δt) |                 |
| Data Input                      | 50 mV/ns        |
| Enable Input                    | 20 mV/ns        |

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 2:** Either voltage limit or current limit is sufficient to protect inputs.

## DC Electrical Characteristics

| Symbol           | Parameter                         | ABT240            |     |      | Units      | V <sub>CC</sub> | Conditions  |
|------------------|-----------------------------------|-------------------|-----|------|------------|-----------------|---|
|                  |                                   | Min               | Typ | Max  |            |                 |   |
| V <sub>IH</sub>  | Input HIGH Voltage                | 2.0               |     |      | V          |                 | Recognized HIGH Signal  |
| V <sub>IL</sub>  | Input LOW Voltage                 |                   |     | 0.8  | V          |                 | Recognized LOW Signal   |
| V <sub>CD</sub>  | Input Clamp Diode Voltage         |                   |     | -1.2 | V          | Min             | I <sub>IN</sub> = -18 mA  |
| V <sub>OH</sub>  | Output HIGH Voltage               | 54ABT             | 2.5 |      | V          | Min             | I <sub>OH</sub> = -3 mA   |
|                  |                                   | 54ABT             | 2.0 |      | V          | Min             | I <sub>OH</sub> = -24 mA  |
| V <sub>OL</sub>  | Output LOW Voltage                | 54ABT             |     | 0.55 | V          | Min             | I <sub>OL</sub> = 48 mA   |
| I <sub>IH</sub>  | Input HIGH Current                |                   | 5   |      | μA         | Max             | V <sub>IN</sub> = 2.7V (Note 4)   |
|                  |                                   |                   |     | 5    |            |                 | V <sub>IN</sub> = V <sub>CC</sub>   |
| I <sub>BVI</sub> | Input HIGH Current Breakdown Test |                   | 7   |      | μA         | Max             | V <sub>IN</sub> = 7.0V  |
| I <sub>IL</sub>  | Input LOW Current                 |                   |     | -5   | μA         | Max             | V <sub>IN</sub> = 0.5V (Note 4)   |
|                  |                                   |                   |     | -5   |            |                 | V <sub>IN</sub> = 0.0V  |
| V <sub>ID</sub>  | Input Leakage Test                | 4.75              |     |      | V          | 0.0             | I <sub>ID</sub> = 1.9 μA<br>All Other Pins Grounded   |
| I <sub>OZH</sub> | Output Leakage Current            |                   |     | 50   | μA         | 0 - 5.5V        | V <sub>OUT</sub> = 2.7V; $\overline{OE}_n = 2.0V$   |
| I <sub>OZL</sub> | Output Leakage Current            |                   |     | -50  | μA         | 0 - 5.5V        | V <sub>OUT</sub> = 0.5V; $\overline{OE}_n = 2.0V$   |
| I <sub>OS</sub>  | Output Short-Circuit Current      | -100              |     | -275 | mA         | Max             | V <sub>OUT</sub> = 0.0V   |
| I <sub>CEX</sub> | Output High Leakage Current       |                   |     | 50   | μA         | Max             | V <sub>OUT</sub> = V <sub>CC</sub>  |
| I <sub>ZZ</sub>  | Bus Drainage Test                 |                   |     | 100  | μA         | 0.0             | V <sub>OUT</sub> = 5.5V; All Others GND   |
| I <sub>CCH</sub> | Power Supply Current              |                   |     | 50   | μA         | Max             | All Outputs HIGH  |
| I <sub>CCL</sub> | Power Supply Current              |                   |     | 30   | mA         | Max             | All Outputs LOW   |
| I <sub>CCZ</sub> | Power Supply Current              |                   |     | 50   | μA         | Max             | $\overline{OE}_n = V_{CC}$ ;<br>All Others at V <sub>CC</sub> or Ground                       |
| I <sub>CC1</sub> | Additional I <sub>CC</sub> /Input | Outputs Enabled   |     | 1.5  | mA         | Max             | V <sub>I</sub> = V <sub>CC</sub> - 2.1V   |
|                  |                                   | Outputs TRI-STATE |     | 1.5  | mA         |                 | Enable Input V <sub>I</sub> = V <sub>CC</sub> - 2.1V  |
|                  |                                   | Outputs TRI-STATE |     | 50   | μA         |                 | Data Input V <sub>I</sub> = V <sub>CC</sub> - 2.1V<br>All Others at V <sub>CC</sub> or Ground |
| I <sub>CCD</sub> | Dynamic I <sub>CC</sub> (Note 4)  | No Load           |     | 0.1  | mA/<br>MHz | Max             | Outputs Open<br>$\overline{OE}_n = GND$ , (Note 3)<br>One Bit Toggling, 50% Duty Cycle        |

**Note 3:** For 8 bits toggling, I<sub>CCD</sub> < 0.8 mA/MHz.

**Note 4:** Guaranteed, but not tested.

## AC Electrical Characteristics

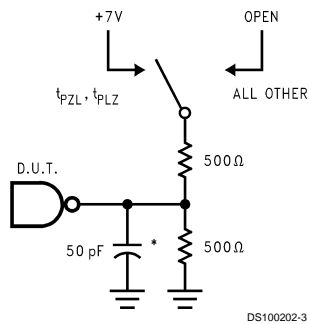
| Symbol    | Parameter         | 54ABT  |     | Units | Fig. No. |
|-----------|-------------------|--|-----|-------|----------|
|           |                   | $T_A = -55^\circ\text{C to } +125^\circ\text{C}$<br>$V_{CC} = 4.5\text{V} - 5.5\text{V}$<br>$C_L = 50\text{ pF}$ |     |       |          |
|           |                   | Min  | Max |       |          |
| $t_{PLH}$ | Propagation Delay | 0.8  | 5.5 | ns    | Figure 5 |
| $t_{PHL}$ | Data to Outputs   | 1.0  | 5.5 |       |          |
| $t_{PZH}$ | Output Enable     | 0.8  | 7.5 | ns    | Figure 4 |
| $t_{PZL}$ | Time              | 0.8  | 7.7 |       |          |
| $t_{PHZ}$ | Output Disable    | 1.0  | 7.5 | ns    | Figure 4 |
| $t_{PLZ}$ | Time              | 1.0  | 7.2 |       |          |

## Capacitance

| Symbol             | Parameter          | Typ | Units | Conditions<br>$T_A = 25^\circ\text{C}$ |
|--------------------|--------------------|-----|-------|--|
| $C_{IN}$           | Input Capacitance  | 5.0 | pF    | $V_{CC} = 0\text{V}$                   |
| $C_{OUT}$ (Note 5) | Output Capacitance | 9.0 | pF    | $V_{CC} = 5.0\text{V}$                 |

Note 5:  $C_{OUT}$  is measured at frequency  $f = 1\text{ MHz}$ , per MIL-STD-883B, Method 3012.

## AC Loading



\*Includes jig and probe capacitance

FIGURE 1. Standard AC Test Load

| Amplitude | Rep. Rate | $t_w$  | $t_r$  | $t_f$  |
|-----------|-----------|--------|--------|--------|
| 3.0V      | 1 MHz     | 500 ns | 2.5 ns | 2.5 ns |

FIGURE 3. Test Input Signal Requirements

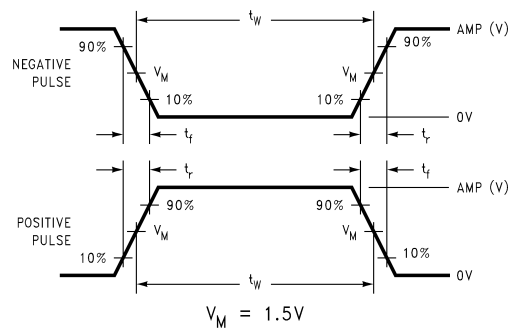
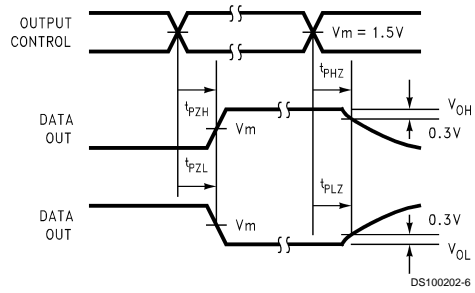
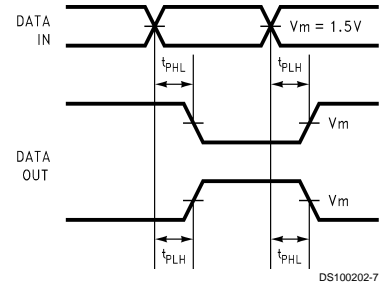


FIGURE 2. Test Input Signal Levels

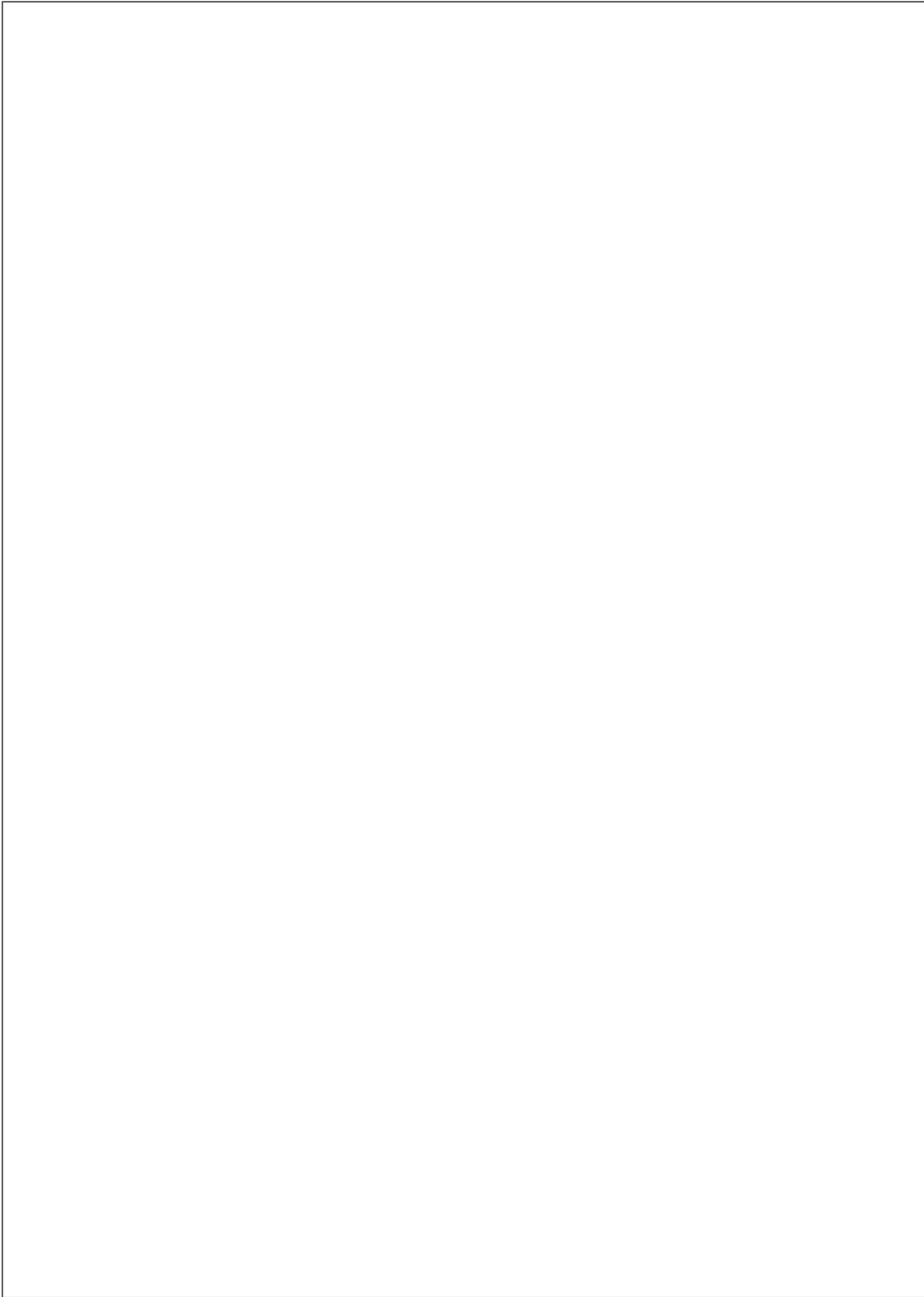
## AC Waveforms



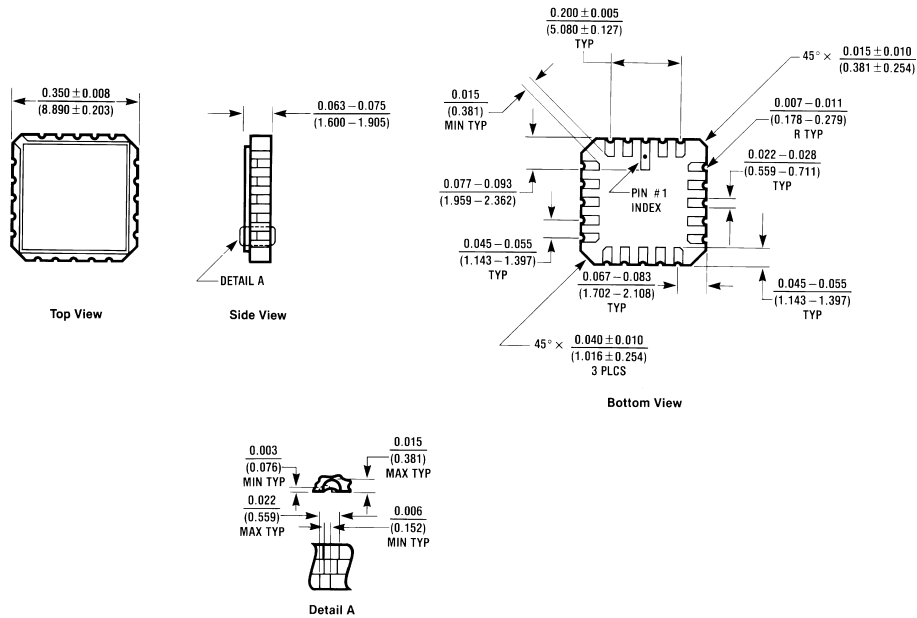
**FIGURE 4. TRI-STATE Output HIGH and LOW Enable and Disable Times**



**FIGURE 5. Propagation Delay Waveforms for Inverting and Non-Inverting Functions**

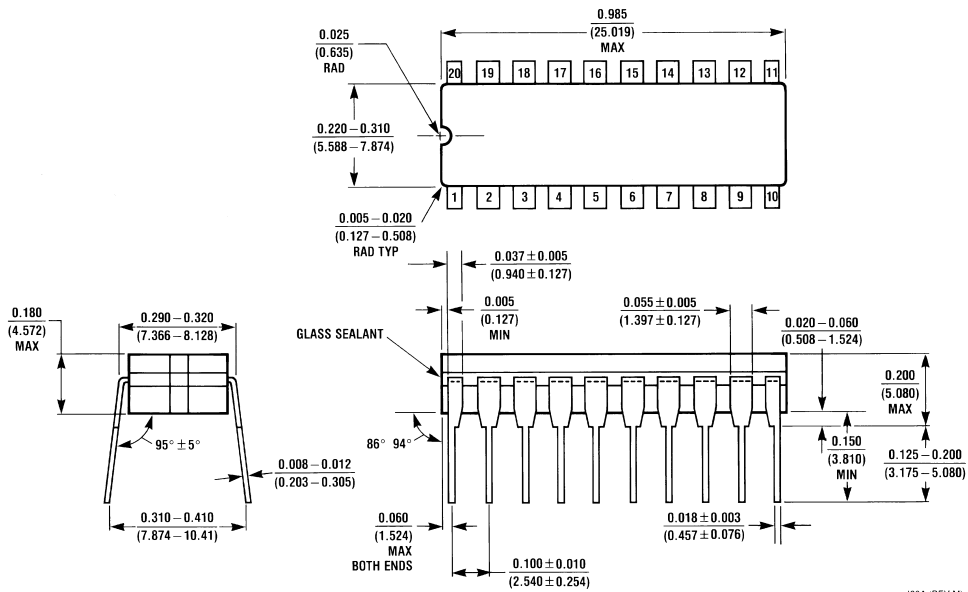


**Physical Dimensions** inches (millimeters) unless otherwise noted



E20A (REV D)

**20-Terminal Ceramic Chip Carrier (L)**  
 NS Package Number E20A

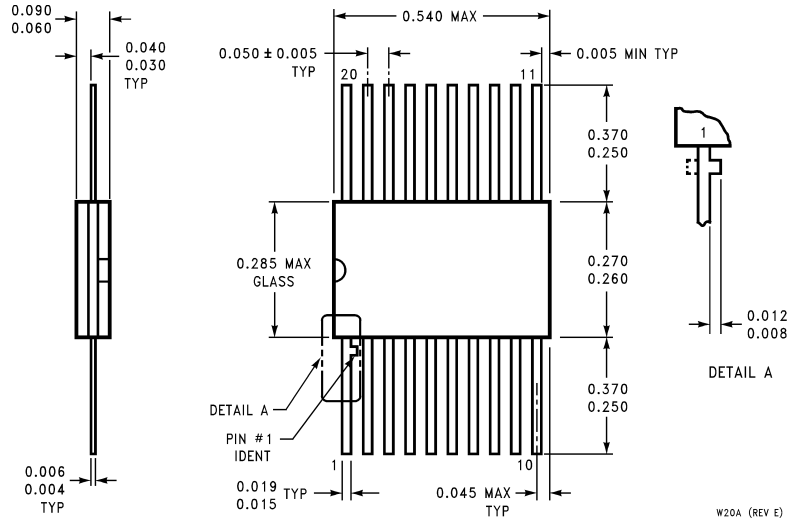


J20A (REV M)

**20-Lead Ceramic Dual-In-Line Package (D)**  
 NS Package Number J20A



**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



**20-Lead Ceramic Flatpak (F)  
NS Package Number W20A**

W20A (REV E)

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